RoHS

COMPLIANT

HALOGEN FREE



Vishay Siliconix

Load Switch with Level-Shift



Marking code: VC

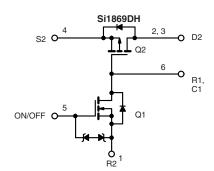
PRODUCT SUMMARY					
V _{D2S2} (V)	-20				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5 \text{ V}$	0.165				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 2.5 \text{ V}$	0.222				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 1.8 \text{ V}$	0.303				
Configuration	Single				

FEATURES

- TrenchFET® power MOSFETs: 1.8 V rated
- ESD protected: 2000 V on input switch, V_{ON/OFF}
- 165 mΩ low R_{DS(on)}
- 1.8 to 20 V input
- 1.5 to 8 V logic level control
- Low profile, small footprint SC-70-6 package
- Adjustable slew-rate
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

Level shift for portable devices



ORDERING INFORMATION	
Package	SOT-363
Lead (Pb)-free	Si1869DH-T1-E3
Lead (Pb)-free and halogen-free	Si1869DH-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage (D2-S2)		V _{DS}	-20		
Input voltage		V _{IN}	20	V	
ON/OFF voltage			8		
Landa wal	Continuous a, b	- IL	± 1.2	А	
Load current	Pulsed b, c		± 3		
Continuous intrinsic diode conduction ^a		I _S	-0.4		
Maximum power dissipation ^a		P _D	1	W	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	
ESD rating, MIL-STD-883D human body model (100 pF, 150	00 Ω)	ESD	2	kV	

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient (continuous current) ^a	R _{thJA}	100	125	°C/W	
Maximum junction-to-foot (Q2)	R _{thJF}	44	55	C/ VV	

Notes

- a. Surface mounted on FR4 board
- b. V_{IN} = 20 V, $V_{ON/OFF}$ = 8 V, T_A = 25 °C
- c. Pulse test: pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$



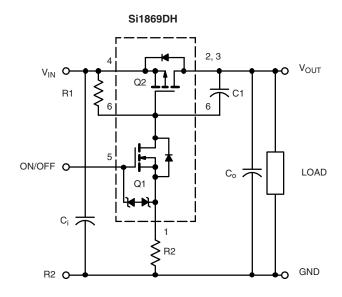
SPECIFICATIONS (T _A = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
OFF Characteristics						
Reverse leakage current	I _{FL}	V _{IN} = 8 V, V _{ON/OFF} = 0 V	-	-	1	μΑ
Diode forward voltage	V_{SD}	I _S = -0.4 A	0.4	0.6	1.1	V
ON Characteristics	ON Characteristics					
Input voltage range a	V _{IN}		1.8	-	20	
Drain to source breakdown voltage (p-channel)	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-20	-	-	V
		$V_{ON/OFF} = 1.5 \text{ V}, V_{IN} = 4.5 \text{ V}, I_D = 1.2 \text{ A}$	-	0.132	0.165	
On-resistance (p-channel) at 1 A	R _{DS(on)}	$V_{ON/OFF} = 1.5 \text{ V}, V_{IN} = 2.5 \text{ V}, I_D = 1 \text{ A}$	-	0.177	0.222	Ω
		$V_{ON/OFF} = 1.5 \text{ V}, V_{IN} = 1.8 \text{ V}, I_D = 0.7 \text{ A}$	-	0.242	0.303	
On state (n shannel) drain surrent	,	$V_{IN-OUT} \le 0.2 \text{ V}, V_{IN} = 5 \text{ V}, V_{ON/OFF} = 1.5 \text{ V}$	1	-	-	۸
On-state (p-channel) drain-current	I _{D(on)}	$V_{IN-OUT} \le 0.3 \text{ V}, V_{IN} = 3 \text{ V}, V_{ON/OFF} = 1.5 \text{ V}$	1	-	-	Α

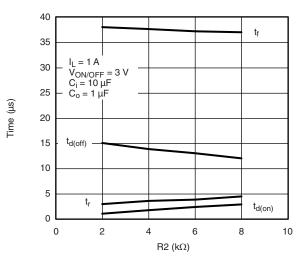
Note

a. $V_{IN} = < 12 \text{ V}$, $V_{ON/OFF} = 8 \text{ V}$, $T_A = 25 \,^{\circ}\text{C}$; recommended application specifications

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

APPLICATION CIRCUITS





Note: For R2 switching variations with other V_{IN}/R1 combinations see Typical Characteristics

Switching Variation R2 at V_{IN} = 2.5 V, R1 = 20 k Ω

COMPONENTS						
R1	Pull-Up Resistor	Typical 10 k Ω to 1 M Ω ^a				
R2	Optional Slew-Rate Control	Typical 0 to 100 k Ω ^a				
C1	Optional Slew-Rate Control	Typical 1000 pF				

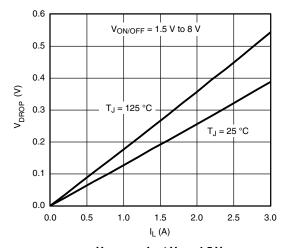
Note

a. Minimum R1 value should be at least 10 x R2 to ensure Q1 turn-on

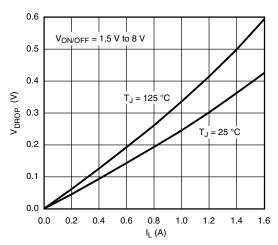
The Si1869DH is ideally suited for high-side load switching in portable applications. The integrated n-channel level-shift device saves space by reducing external components. The slew rate is set externally so that rise-times can be tailored to different load types.



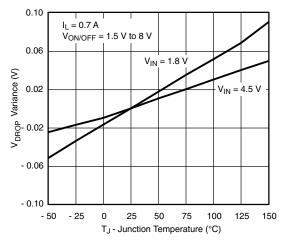
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



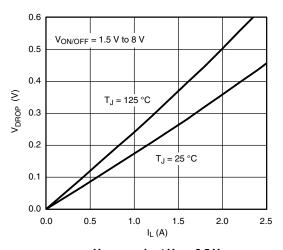
 V_{DROP} vs. I_L at V_{IN} = 4.5 V



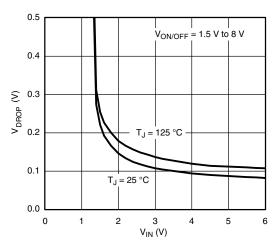
V_{DROP} vs. I_L at V_{IN} = 1.8 V



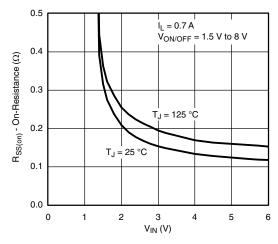
V_{DROP} Variance vs. Junction Temperature



 V_{DROP} vs. I_L at $V_{IN} = 2.5 \text{ V}$



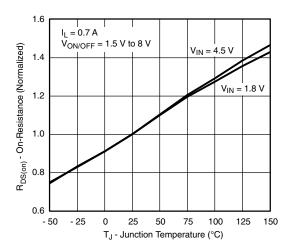
 V_{DROP} vs. V_{IN} at $I_L = 0.7$ A



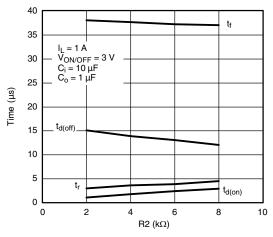
On-Resistance vs. Input Voltage



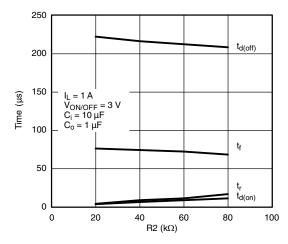
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



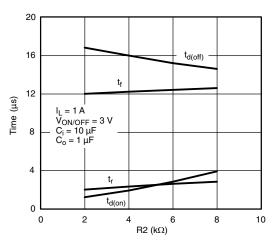
Normalized On-Resistance vs. Junction Temperature



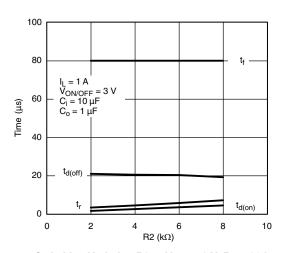
Switching Variation R2 at V_{IN} = 2.5 V, R1 = 20 k Ω



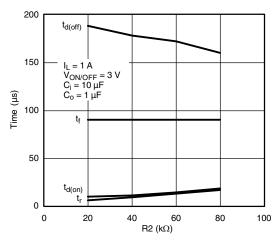
Switching Variation R2 at V_{IN} = 4.5 V, R1 = 300 k Ω



Switching Variation R2 at V_{IN} = 4.5 V, R1 = 20 k Ω



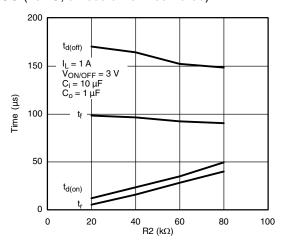
Switching Variation R2 at V_{IN} = 1.8 V, R1 = 20 k Ω



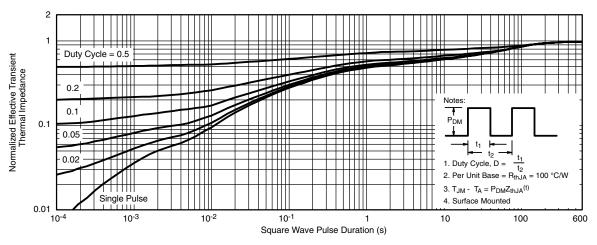
Switching Variation R2 at V_{IN} = 2.5 V, R1 = 300 k Ω



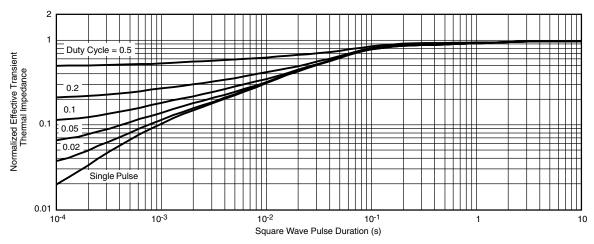
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Switching Variation R2 at V_{IN} = 1.8 V, R1 = 300 k Ω



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SC-70: 6-LEADS





	MILLIMETERS INCHES			S		
Dim	Min	Nom	Max	Min	Nom	Max
Α	0.90	-	1.10	0.035	_	0.043
A ₁	-	-	0.10	-	-	0.004
A_2	0.80	-	1.00	0.031	-	0.039
b	0.15	-	0.30	0.006	_	0.012
С	0.10	-	0.25	0.004	_	0.010
D	1.80	2.00	2.20	0.071	0.079	0.087
Ε	1.80	2.10	2.40	0.071	0.083	0.094
E ₁	1.15	1.25	1.35	0.045	0.049	0.053
е	0.65BSC				0.026BSC	;
e ₁	1.20	1.30	1.40	0.047	0.051	0.055
L	0.10	0.20	0.30	0.004	0.008	0.012
9	7°Nom 7°Nom					



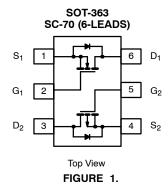
Dual-Channel LITTLE FOOT® 6-Pin SC-70 MOSFET Copper Leadframe Version Recommended Pad Pattern and Thermal Performance

INTRODUCTION

The new dual 6-pin SC-70 package with a copper leadframe enables improved on-resistance values and enhanced thermal performance as compared to the existing 3-pin and 6-pin packages with Alloy 42 leadframes. These devices are intended for small to medium load applications where a miniaturized package is required. Devices in this package come in a range of on-resistance values, in n-channel and p-channel versions. This technical note discusses pin-outs, package outlines, pad patterns, evaluation board layout, and thermal performance for the dual-channel version.

PIN-OUT

Figure 1 shows the pin-out description and Pin 1 identification for the dual-channel SC-70 device in the 6-pin configuration. Both n-and p-channel devices are available in this package — the drawing example below illustrates the p-channel device.



For package dimensions see outline drawing SC-70 (6-Leads) (http://www.vishay.com/doc?71154)

BASIC PAD PATTERNS

See Application Note 826, Recommended Minimum Pad Patterns With Outline Drawing Access for Vishay Siliconix MOSFETs, (http://www.vishay.com/doc?72286) for the SC-70 6-pin basic pad layout and dimensions. This pad pattern is sufficient for the low-power applications for which this package is intended. Increasing the drain pad pattern (Figure 2) yields a reduction in thermal resistance and is a preferred footprint.

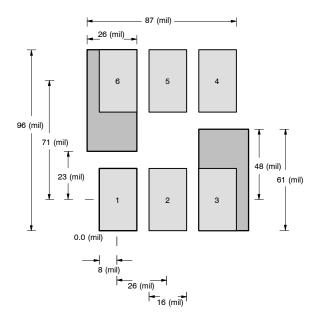


FIGURE 2. SC-70 (6 leads) Dual

EVALUATION BOARD FOR THE DUAL-CHANNEL SC70-6

The 6-pin SC-70 evaluation board (EVB) shown in Figure 3 measures 0.6 in. by 0.5 in. The copper pad traces are the same as described in the previous section, *Basic Pad Patterns*. The board allows for examination from the outer pins to the 6-pin DIP connections, permitting test sockets to be used in evaluation testing.

The thermal performance of the dual 6-pin SC-70 has been measured on the EVB, comparing both the copper and Alloy 42 leadframes. This test was then repeated using the 1-inch² PCB with dual-side copper coating.

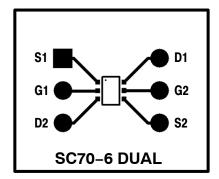
A helpful way of displaying the thermal performance of the 6-pin SC-70 dual copper leadframe is to compare it to the traditional Alloy 42 version.

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Front of Board SC70-6



Back of Board SC70-6

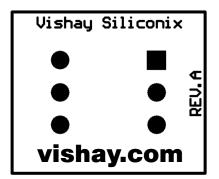


FIGURE 3.

THERMAL PERFORMANCE

Junction-to-Foot Thermal Resistance (the Package Performance)

Thermal performance for the dual SC-70 6-pin package is measured as junction-to-foot thermal resistance, in which the "foot" is the drain lead of the device as it connects with the body. The junction-to-foot thermal resistance for this device is typically 80°C/W, with a maximum thermal resistance of approximately 100°C/W. This data compares favorably with another compact, dual-channel package - the dual TSOP-6 which features a typical thermal resistance of 75°C/W and a maximum of 90°C/W.

Power Dissipation

The typical $R\theta_{JA}$ for the dual-channel 6-pin SC-70 with a copper leadframe is 224°C/W steady-state, compared to 413°C/W for the Alloy 42 version. All figures are based on the 1-inch² FR4 test board. The following example shows how the thermal resistance impacts power dissipation for the dual 6-pin SC-70 package at varying ambient temperatures.

Alloy 42 Leadframe

ALLOY 42 LEADFRAME					
Room Ambient 25 °C	Elevated Ambient 60 °C				
$P_D = \frac{T_{J(max)} - T_A}{R\theta_{JA}}$	$P_D = \frac{T_{J(max)} - T_A}{R\theta_{JA}}$				
$P_{D} = \frac{150^{\circ}C - 25^{\circ}C}{413^{\circ}C/W}$	$P_{D} = \frac{150^{\circ}C - 60^{\circ}C}{413^{\circ}C/W}$				
$P_D = 303 \text{ mW}$	$P_D = 218 \text{ mW}$				

COOPER LEADFRAME					
Room Ambient 25 °C	Elevated Ambient 60 °C				
$P_D = \frac{T_{J(max)} - T_A}{R\theta_{JA}}$	$P_D = \frac{T_{J(max)} - T_A}{R\theta_{JA}}$				
$P_{D} = \frac{150^{\circ}C - 25^{\circ}C}{224^{\circ}C/W}$	$P_{D} = \frac{150^{\circ}C - 60^{\circ}C}{224^{\circ}C/W}$				
$P_D = 558 \text{ mW}$	$P_D = 402 \text{ mW}$				

Although they are intended for low-power applications, devices in the 6-pin SC-70 dual-channel configuration will handle power dissipation in excess of 0.5 W.

TESTING

To further aid the comparison of copper and Alloy 42 leadframes, Figures 4 and 5 illustrate the dual-channel 6-pin SC-70 thermal performance on two different board sizes and pad patterns. The measured steady-state values of $R\theta_{JA}$ for the dual 6-pin SC-70 with varying leadframes are as follows:

LITTLE FOOT 6-PIN SC-70						
Alloy 42 Copper						
Minimum recommended pad pattern on the EVB board (see Figure 3).	518°C/W	344°C/W				
Industry standard 1-inch ² PCB with maximum copper both sides.	413°C/W	224°C/W				

The results indicate that designers can reduce thermal resistance (θJA) by 34% simply by using the copper leadframe device as opposed to the Alloy 42 version. In this example, a 174°C/W reduction was achieved without an increase in board area. If an increase in board size is feasible, a further 120°C/W reduction can be obtained by utilizing a 1-inch². PCB area.

The Dual copper leadframe versions have the following suffix:

Dual: Si19xxEDH Si15xxEDH Compl.:

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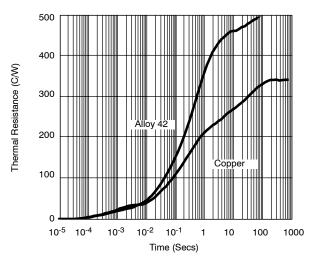


FIGURE 4. Dual SC70-6 Thermal Performance on EVB

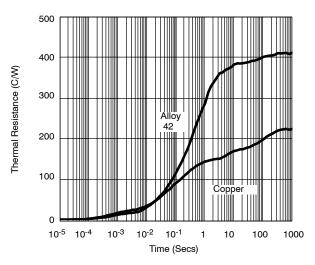


FIGURE 5. Dual SC70-6 Comparison on 1-inch² PCB



RECOMMENDED MINIMUM PADS FOR SC-70: 6-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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